



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re U.S. Patent Application of)

SHIMAMOTO *et al.*)

Application Number: 10/020,314)

Filed: December 18, 2001)

For: FABRICATING METHOD OF SEMICONDUCTOR)
INTEGRATED CIRCUITS)

ATTORNEY DOCKET NO. HITA.0143)

Art unit: 2823

Examiner:

NGUYEN, KHIEM D.

RECEIVED
AUG 11 2003
TECHNOLOGY CENTER 2800

Honorable Assistant Commissioner
for Patents
Washington, D.C. 20231

COVER LETTER

Sir:

[] The fee for submission of additional claims is calculated as shown below:

FOR	TOTAL WITH NEW CLAIMS ADDED	TOTAL CURRENTLY ON FILE	CLAIMS PAID	RATE	CALCULATION
Total Claims	20	20	(Over 20)	x \$18	0
Independent Claims	2	2	(Over 3)	x \$84	0
MULTIPLE DEPENDENT CLAIM(S)				+ \$280	0
REDUCTION FOR FILING BY SMALL ENTITY (note 37 C.F.R. §§ 1.9, 1.27, 1.28). IF APPLICABLE, VERIFIED STATEMENT MUST BE ATTACHED				x ½	
				TOTAL	0.00

In addition, the below-identified communications are submitted in the above-captioned application or proceeding:

[x] Response to Office Action
(with Claim Amendments)

[] Preliminary Amendment

[] Substitute Specification

[] Other _____

[] Petition for Extension of Time

[] Terminal Disclaimer

[] Letter to Draftsperson

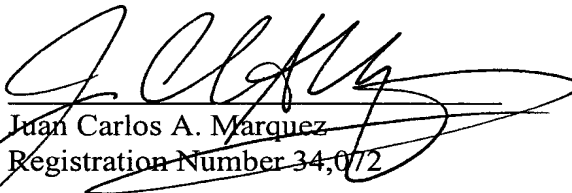
[] Assignment

[] Petition under _____

- [] Please charge my **Deposit Account Number** _____ in the amount of _____ to cover the fees for _____. A duplicate copy of this paper is enclosed.
- [] A check in the amount of **\$0.00** to cover the fee is enclosed.
- [x] The Commissioner is hereby authorized to charge any additional fees associated with this communication, including patent application filing fees and processing fees under 37 C.F.R. § 1.16 and 1.17, or credit any overpayment to **Deposit Account Number 08-1480**.

Respectfully submitted,

Stanley P. Fisher
Registration Number 24,344



Juan Carlos A. Marquez
Registration Number 34,072

REED SMITH LLP
3110 Fairview Park Drive, Suite 1400
Falls Church, Virginia 22042
(703) 641-4200
August 6, 2003